MOSFET - SiC Power, Single N-Channel, D2PAK-7L 1200 V, 20 mΩ, 98 A

NVBG020N120SC1

Features

- Typ. $R_{DS(on)} = 20 \text{ m}\Omega$
- Ultra Low Gate Charge (typ. Q_{G(tot)} = 220 nC)
- Low Effective Output Capacitance (typ. Coss = 258 pF)
- 100% Avalanche Tested
- Qualified According to AEC-Q101
- RoHS Compliant

Typical Applications

- Automotive On Board Charger
- Automotive DC/DC Converter for EV/HEV

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V_{DSS}	1200	V	
Gate-to-Source Voltage		V_{GS}	-15/+25	V	
Recommended Operation Values of Gate-to-Source Voltage		T _C < 175°C	V_{GSop}	-5/+20	V
Continuous Drain Current (Note 2)	Steady State	T _C = 25°C	I _D	98	Α
Power Dissipation (Note 2)			P _D	468	W
Continuous Drain Current (Notes 1, 2)	Steady State	T _A = 25°C	I _D	8.6	Α
Power Dissipation (Notes 1, 2)			P _D	3.7	W
Pulsed Drain Current (Note 3)	T _A = 25°C		I _{DM}	392	Α
Single Pulse Surge Drain Current Capa- bility	T_A = 25°C, t_p = 10 μ s, R_G = 4.7 Ω		I _{DSC}	807	Α
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)		I _S	46	Α	
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 23 A, L = 1 mH) (Note 4)		E _{AS}	264	mJ	
Maximum Lead Temperature for Soldering (1/8" from case for 5 s)		TL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

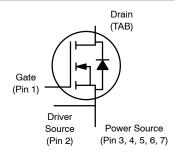
- 1. Surface mounted on a FR-4 board using1 in2 pad of 2 oz copper.
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 3. Repetitive rating, limited by max junction temperature.
- 4. EAS of 264 mJ is based on starting $T_J = 25^{\circ} \mbox{C}$; L = 1 mH, $I_{AS} = 23$ A, $V_{DD} = 120$ V, $V_{GS} = 18$ V.



ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
1200 V	28 mΩ @ 20 V	98 A



N-CHANNEL MOSFET



D2PAK-7L CASE 418BJ

MARKING DIAGRAM

AYWWZZ NVBG 020120SC1

A = Assembly Location

Y = Year WW = Work Week ZZ = Lot Traceability

NVBG020120SC1 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NVBG020N120SC1	D2PAK-7L	800 ea/ Tape&Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case - Steady State (Note 2)	$R_{ heta JC}$	0.32	°C/W
Junction-to-Ambient - Steady State (Notes 1, 2)	$R_{ hetaJA}$	41	

ELECTRICAL CHARACTERISTICS (T_{.I} = 25°C unless otherwise specified)

Parameter OFF CHARACTERISTICS Drain-to-Source Breakdown Voltage Drain-to-Source Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate-to-Source Leakage Current ON CHARACTERISTICS (Note 3) Gate Threshold Voltage	V _{(BR)DSS} V _{(BR)DSS} /T _J		1 mA	Min 1200	Тур	Max	Unit
Drain-to-Source Breakdown Voltage Drain-to-Source Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate-to-Source Leakage Current ON CHARACTERISTICS (Note 3) Gate Threshold Voltage	V _{(BR)DSS} /T _J	I _D = 1 mA, reference		1200			
Drain-to-Source Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate-to-Source Leakage Current ON CHARACTERISTICS (Note 3) Gate Threshold Voltage	V _{(BR)DSS} /T _J	I _D = 1 mA, reference		1200			
Temperature Coefficient Zero Gate Voltage Drain Current Gate-to-Source Leakage Current ON CHARACTERISTICS (Note 3) Gate Threshold Voltage			LI- OFOO				V
Gate-to-Source Leakage Current ON CHARACTERISTICS (Note 3) Gate Threshold Voltage	I _{DSS}	V00 = 0 V	I_D = 1 mA, referenced to 25°C		0.5		V/°C
ON CHARACTERISTICS (Note 3) Gate Threshold Voltage		$V_{GS} = 0 \text{ V}, V_{DS} = 1200 \text{ V}$	$T_J = 25^{\circ}C$			100	μΑ
ON CHARACTERISTICS (Note 3) Gate Threshold Voltage		V _{DS} = 1200 V	T _J = 175°C			1	mA
Gate Threshold Voltage	I_{GSS}	$V_{GS} = +25/-15 V$,	$V_{DS} = 0 V$			±1	μΑ
	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	20 mA	1.8	2.7	4.3	V
Recommended Gate Voltage	V_{GOP}			-5		+20	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 20 V, I _D = 60 .	A, T _J = 25°C		20	28	mΩ
		V _{GS} = 20 V, I _D = 60 A	A, T _J = 175°C		35	50	Ì
Forward Transconductance	9FS	$V_{DS} = 20 \text{ V}, I_{D}$	= 60 A		34		S
CHARGES, CAPACITANCES & GATE RESI	STANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 800 V			2943		pF
Output Capacitance	C _{OSS}				258		
Reverse Transfer Capacitance	C _{RSS}				24		Ì
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -5/20 \text{ V}, V_{DS} = 600 \text{ V},$ $I_{D} = 80 \text{ A}$			220		nC
Threshold Gate Charge	Q _{G(TH)}				33		Ì
Gate-to-Source Charge	Q _{GS}				66		Ì
Gate-to-Drain Charge	Q_{GD}				63		Ì
Gate-Resistance	R _G	f = 1 MHz	<u>z</u>		1.6		Ω
SWITCHING CHARACTERISTICS					•	-	
Turn-On Delay Time	t _{d(ON)}	$\begin{array}{l} V_{GS}=-5/20 \text{ V,} \\ V_{DS}=800 \text{ V,} \\ I_{D}=80 \text{ A,} \\ R_{G}=2 \Omega \\ \text{inductive load} \end{array}$			22	35	ns
Rise Time	t _r				20	32	Ì
Turn-Off Delay Time	t _{d(OFF)}				42	67	Ì
Fall Time	t _f				9	18	İ
Turn-On Switching Loss	E _{ON}				461		μJ
Turn-Off Switching Loss	E _{OFF}				400		· I
Total Switching Loss	E _{tot}				861		Ì
DRAIN-SOURCE DIODE CHARACTERISTI							
Continuous Drain-Source Diode Forward Current	I _{SD}	V _{GS} = -5 V, T _J	= 25°C			46	Α
Pulsed Drain-Source Diode Forward Current (Note 3)	I _{SDM}					392	1
Forward Diode Voltage	V _{SD}	V _{GS} = -5 V, I _{SD} = 30	A, T _J = 25°C		3.7		V
Reverse Recovery Time	t _{RR}	$V_{GS} = -5/20 \text{ V, I}_{S}$	-		31		ns
Reverse Recovery Charge	Q _{RR}	dl _S /dt = 1000 A/μs			228		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

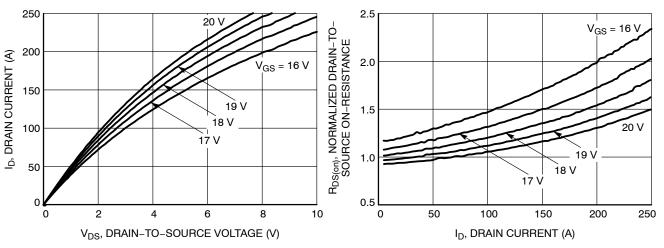


Figure 1. On-Region Characteristics

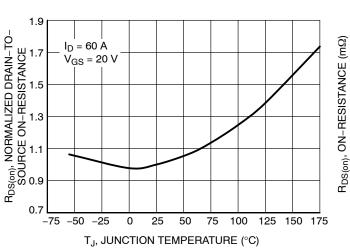


Figure 3. On–Resistance Variation with Temperature

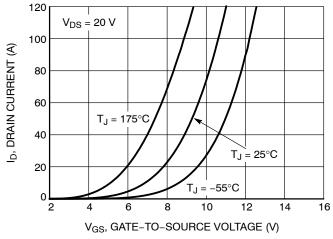


Figure 5. Transfer Characteristics

Figure 2. Normalized On–Resistance vs. Drain Current and Gate Voltage

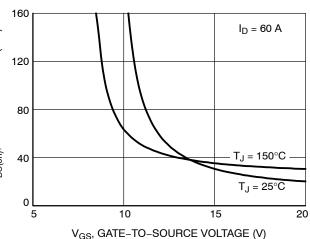


Figure 4. On-Resistance vs. Gate-to-Source Voltage

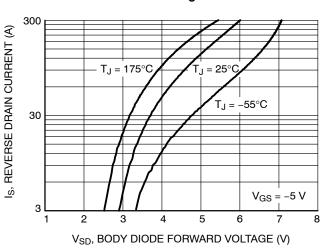


Figure 6. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS

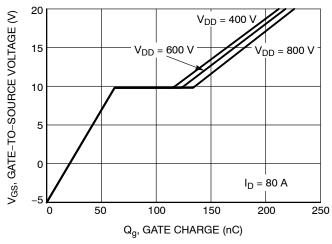


Figure 7. Gate-to-Source Voltage vs. Total Charge

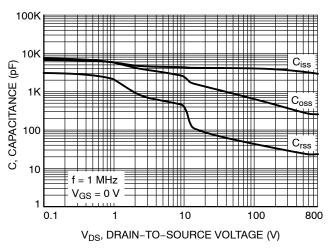


Figure 8. Capacitance vs. Drain-to-Source Voltage

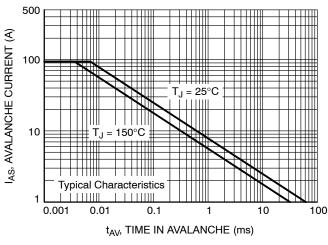


Figure 9. Unclamped Inductive Switching Capability

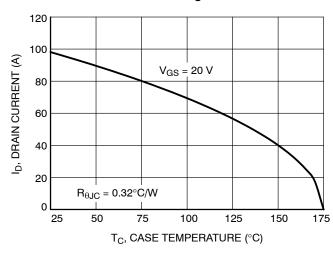


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

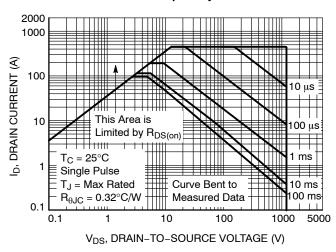


Figure 11. Maximum Rated Forward Biased Safe Operating Area

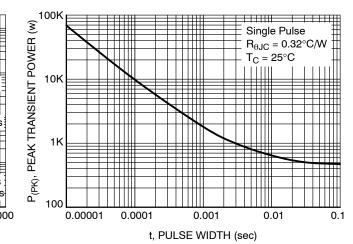


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS

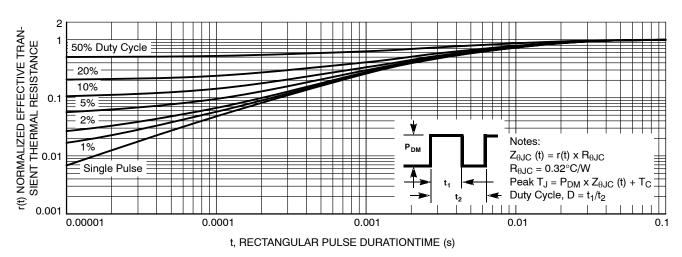


Figure 13. Junction-to-Case Transient Thermal Response Curve

D²PAK7 (TO-263-7L HV) CASE 418BJ **ISSUE B**

DATE 16 AUG 2019

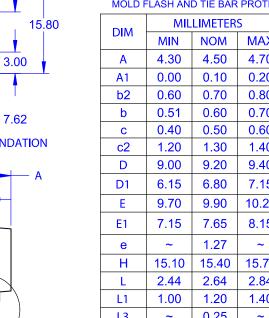
NOTES:

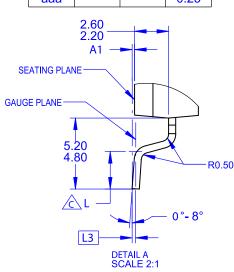
- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED. B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE.

 D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.

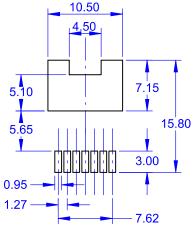
 E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

DIM	MIL	LIMETER	METERS		
MIN		NOM	MAX		
Α	4.30	4.50	4.70		
A1	0.00	0.10	0.20		
b2	0.60	0.70	0.80		
b	0.51	0.60	0.70		
С	0.40	0.50	0.60		
c2	1.20	1.30	1.40		
D	9.00	9.20	9.40		
D1	6.15	6.80	7.15		
Е	9.70	9.90	10.20		
E1	7.15	7.65	8.15		
е	~	1.27	~		
Н	15.10	15.40	15.70		
L	2.44	2.64	2.84		
L1	1.00	1.20	1.40		
L3	~	0.25	~		
aaa	~	~	0.25		

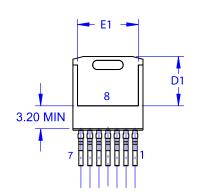


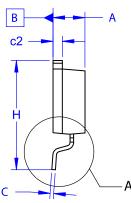


Α L1 D aaa | B | A |M



LAND PATTERN RECOMMENDATION





GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code = Assembly Location

= Year WW = Work Week G = Pb-Free Package

*This information is generic. Please refer to

device data sneet for actual part marking.
Pb-Free indicator, "G" or microdot "■", may
or may not be present. Some products may
not follow the Generic Marking.
_

Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98AON84234G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** D²PAK7 (TO-263-7L HV) **PAGE 1 OF 1**

ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B DMN1006UCA6-7